





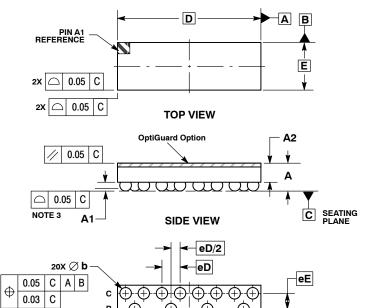
WLCSP20, 3.16x1.05 CASE 567CN ISSUE O

DATE 26 JUL 2010

NOTES:

- DIMENSIONING AND TOLERANCING PER
 ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 COPLANARITY APPLIES TO SPHERICAL
 CROWNS OF SOLDER BALLS.

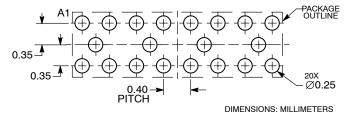
	MILLIMETERS		
DIM	MIN	MAX	
Α	0.57	0.72	
A1	0.17	0.24	
A2	0.42 REF		
b	0.24	0.29	
D	3.16 BSC		
E	1.05 BSC		
eD	0.400 BSC		
eΕ	0.347 BSC		



RECOMMENDED SOLDERING FOOTPRINT*

BOTTOM VIEW

101112



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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